## 504101995 11/17/2016

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
CHAO-CHENG LIN	11/09/2016
CHIEN-KAI PENG	11/09/2016
CHEN-CHENG LIN	11/09/2016
CHEN-HSUN DU	11/09/2016
CHORNG-JYE HUANG	11/09/2016
CHUN-MING YEH	11/09/2016

### **RECEIVING PARTY DATA**

Name:	INDUSTRIAL TECHNOLOGY RESEARCH INSTITUTE
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State/Country:	TAIWAN
Postal Code:	31040

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15351455

### **CORRESPONDENCE DATA**

**Fax Number:** (510)580-7280

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ATTORNEY DOCKET NUMBER:	62773-US-PA
NAME OF SUBMITTER:	BELINDA LEE
SIGNATURE:	/Belinda Lee/
DATE SIGNED:	11/17/2016

**Total Attachments: 2** 

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## **ASSIGNMENT**

WHEREAS,

1. Chao-Cheng Lin

2. Chien-Kai Peng

3. Chen-Cheng Lin

4. Chen-Hsun Du

5. Chorng-Jye Huang

6. Chun-Ming Yeh

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: SOLAR CELL

[ ] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS 1. Industrial Technology Research Institute

of No. 195, Sec. 4, Chung Hsing Rd., Chutung, Hsinchu 31040, Taiwan, R. O. C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have assigned and transferred, and by these presents does/do assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

# **ASSIGNMENT CONTINUED**

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Chao - Cheng Lin Sole or First Joint Inventor: Chao-Cheng Lin	Date: 1/09 7016
Signature: Chien - Kai Peng Second Joint Inventor (if any): Chien-Kai Peng	Date: 11/06 2016
Signature: There Chang Low Third Joint Inventor (if any): Chen-Cheng Lin	Date: 1/9 -16
Signature: Clan Hsm Du Fourth Joint Inventor (if any): Chen-Hsun Du	Date: 11/4 2616
Signature: Chorng Tye Huang  Fifth Joint Inventor (if any): Chorng-Jye Huang	Date: 1/09, 20/6

Signature: than-May Yoh Date: 11/9 2016

Sixth Joint Inventor (if any): Chun-Ming Yeh

**RECORDED: 11/17/2016**